



UNIVERSITY  
of SOPRON

FACULTY OF WOOD  
ENGINEERING AND  
CREATIVE INDUSTRIES

# 10<sup>th</sup> HARDWOOD Conference Proceedings

12–14 October 2022 Sopron

Editors: Róbert Németh, Christian Hansmann, Peter Rademacher, Miklós Bak, Mátyás Báder



WOOD  
KPLUS

Mendel  
University  
in Brno



# **10<sup>TH</sup> HARDWOOD CONFERENCE PROCEEDINGS**

**Editors: Róbert Németh, Christian Hansmann, Peter Rademacher,  
Miklós Bak, Mátyás Báder**



**UNIVERSITY OF SOPRON PRESS**

**SOPRON, 2022**

# 10<sup>TH</sup> HARDWOOD CONFERENCE PROCEEDINGS

Sopron, Hungary, 12-14 October 2022

## Editorial board

Prof. Dr. Róbert Németh

Dr. Christian Hansmann

Dr. Peter Rademacher

Dr. Miklós Bak

Dr. Mátyás Báder

[University of Sopron](#) – Hungary

[FATE - Wood Science Association](#) – Hungary

[Wood K Plus](#) – Austria

[Mendel University in Brno](#) – Czech Republic

[University of Sopron](#) – Hungary

[University of Sopron](#) – Hungary

[FATE - Wood Science Association](#) – Hungary

## Scientific committee

Prof. Dr. Dr. h.c. Peter Niemz

Prof. Dr. Dr. h.c. Alfred Teischinger

Prof. Dr. Željko Gorišek

Prof. Dr. George I. Mantanis

Prof. Dr. Bartłomiej Mazela

Prof. Dr. Julia Mihailova

Prof. Dr. Holger Miltz

Prof. Dr. Joris Van Acker

Prof. Dr. Ali Temiz

Prof. Dr. Dick Sandberg

Dr. Milan Gaff

Dr. Galina Gorbacheva

Dr. Henrik Heräjärvi

Dr. Andreja Kutnar

Dr. Rastislav Lagana

Dr. Goran Milić

Dr. Lê Xuân Phương

Dr. Emilia-Adela Salca

Dr. Vjekoslav Živković

[ETH Zürich](#) – Switzerland / [Luleå University of Technology](#) – Sweden

[BOKU University Vienna](#) – Austria

[University of Ljubljana](#) – Slovenia

[University of Thessaly](#) – Greece

[Poznań University of Life Sciences](#) – Poland

[University of Forestry](#) – Bulgaria

[Georg-August University Göttingen](#) – Germany

[Ghent University](#) – Belgium

[Karadeniz Technical University](#) – Turkey

[Luleå University of Technology](#) – Sweden

[Czech University of Life Sciences](#) – Czech Republic

[Bauman Moscow State Technical University](#) – Russian Federation

[Natural Resources Institute Finland \(LUKE\)](#) – Finland

[InnoRenew CoE](#) – Slovenia

[TU Zvolen](#) – Slovak Republic

[University of Belgrade](#) – Serbia

[Vietnam National University of Forestry](#) – Vietnam

[“Transilvania” University of Brasov](#) – Romania

[University of Zagreb](#) – Croatia

## Cover design

Gergő Bogáti

[University of Sopron](#) – Hungary

## Webservices

Miklós Bak

[10<sup>th</sup> Hardwood Conference official website](#)

[University of Sopron](#) – Hungary

ISBN 978-963-334-446-0 (pdf)

DOI <https://doi.org/10.35511/978-963-334-446-0>

ISSN 2631-004X (Hardwood Conference Proceedings)

Constant Serial Editors: Róbert Németh, Miklós Bak

Cover image based on the beech specimens of Radim Rousek and Mátyás Báder by Miklós Bak, 2021

The manuscripts have been peer-reviewed by the editors and have not been subjected to linguistic revision.

In the articles, corresponding authors are marked with an asterisk (\*) sign.

[University of Sopron Press](#), 2022

Responsible for publication: Prof. Dr. Attila Fábián, rector of the [University of Sopron](#)

© All rights reserved



UNIVERSITY  
of SOPRON

WOOD  
K PLUS



## Enhancing the internal bonding after boiling for particleboard made of recycled furniture

Fatima Zohra Brahmia<sup>1\*</sup>, Gábor Kun<sup>1</sup>, Rami Benkreif<sup>2</sup>, Tibor Alpár<sup>1</sup>

<sup>1</sup>University of Sopron. Faculty of Wood Engineering and Creative Industries. Institute of Wood - based products and Technologies. H-9400 Sopron, Bajcsy-Zs.E.u.4. Hungary

<sup>2</sup>University of Sopron. Faculty of Wood Engineering and Creative Industries. Institute of Wood Engineering Institute of Wood - based products and Technologies g. H-9400 Sopron, Bajcsy-Zs.E.u.4. Hungary

E-mail: [brahmia.fatima.zohra@uni-sopron.hu](mailto:brahmia.fatima.zohra@uni-sopron.hu); [kun.gabor@uni-sopron.hu](mailto:kun.gabor@uni-sopron.hu); [rami.benkreif@phd.uni-sopron.hu](mailto:rami.benkreif@phd.uni-sopron.hu); [alpar.tibor@uni-sopron.hu](mailto:alpar.tibor@uni-sopron.hu)

**Keywords:** Recycled wood, internal bond, adhesive, particle board

### ABSTRACT

Wood is renewable resource that play a major role in wood and wood based products, and energy production. In recent years, interest growth in application of recycled wood since it has a direct impact on carbon footprint. The carbon dioxide released in the atmosphere in wood combustion is the same absorbed by the tree during growth; the released CO<sub>2</sub> is collected again within a neutral carbon cycle. As a result, it does not contribute to global warming, However, recycled materials like the production and particleboard keeps the absorbed carbon continuously inside the wood products for a long period (Kim and Song, 2014). The aim of this research work is to increase the internal bonding (IB) of particleboard after boiling. A series of experiments were conducted, in order to optimize the recipe for the production of recycled wood-based particleboard. For this a low formaldehyde emission, water and cooking resistant glue would be the perfect solution. The particleboard must fulfil the standard (EN 1087-1:1996). The most critical tests are internal bonding after boiling and formaldehyde emission. Pallet blocks need an adhesive that can withstand 2 hours of boiling and then 1 hour of soaking in 20 °C water. Thereafter, they should still be able to provide 0.25 MPa of tensile strength when wet. Based on previous knowledge, phenol and melamine formaldehyde adhesives may fulfil these requirements. Phenol formaldehyde with 41.5 % dry matter content, melamine formaldehyde with 65 % of dry matter content recycled (hammer milled) melamine-faced particleboard, hardener were used to produce boards with dimension of (300 x 300 x 25) mm. Different pressing force and time were used with different amount of adhesive and hardener. As a result, it was found that melamine formaldehyde is suitable to increase the IB, using 14 % of melamine formaldehyde increased the IB to 0.26 MPa with density of 0.655 g/cm<sup>3</sup>. In other hand, phenol-formaldehyde was not good.

### INTRODUCTION

The insufficiency of the supply of wood is one of the main problems impeding the development of particleboard industry. This issue was occurred because of the growing demands on wood from many branches of the wood processing industry, as well as the energy sector that utilises the wood as biomass, based on the EU recommendation concerning the energy from renewable sources. Good lumber management could involve its reduced consumption in the production of wood composites, through the manufacturing of wood composites with a decreased density, which compared to the density of the standard boards in the respective groups of materials. Furniture manufacturer shown big interest in decreasing the particleboard density. Many factors could be the reason of such decision that could be related to not only ecological reason but also other important considerations that involve economic factors, like decreasing the transportation and installation cost, and ergonomic factors, i.e., easier assembly or improved functionality (Dziurka et.al 2015).

Recent year's production of sustainable material grows more and more, material recycling of wood waste involved the manufacturing of particleboard or MDF (medium density fibreboard). These methods have the advantage of repeated recycling under separate collection. Industrial wood residues such as shavings,



sawdust, plywood trim, fine particles, chips, or urban wood waste chips are the main materials used in particleboard production. It is mostly used in industries as a replacement material for making household or office furniture, kitchen and bath cabinets, store fixtures, door components and, to a small degree, in flooring (Kim and Song, 2014).

The formaldehyde emission from furniture made of thermosetting resins like melamine resin is famous. Formaldehyde emission from plastic was the main concern of many countries, which lead them to set different regulation and requirements. Among the various resins, melamine resins was used in many useful products. For example, in coating technology, it was used to modify the adhesion properties of other materials they also may be included as curing elements for other resin (Devallencourt et al. 1995). The aim of this research work is to increase internal bond of particleboard after boiling in water and decrease its formaldehyde emission.

## EXPERIMENTAL METHODS

Phenol formaldehyde with 48.9 % dry matter content, melamine formaldehyde with dry matter of 65 %, recycled (hammer milled) melamine-faced particleboard, hardener were used to produce boards with dimension of (30x30x2.5) cm. Settings are represented in the Table 1.

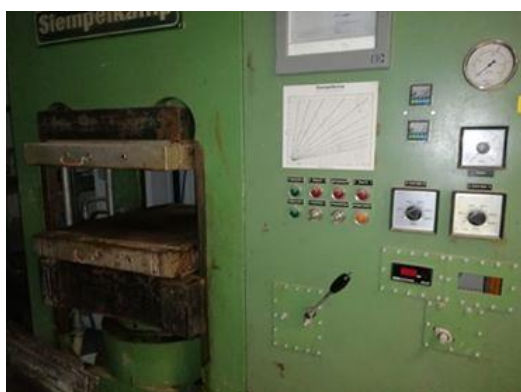


Figure 1: Seimpelkamp press

Table 1: Board recipe

Board ID	Adhesive Amount (%)	Hardener Amount (%)	Pressing temperature (°C)	Pressing time (s)
Ph-10-130-8 <sup>a</sup>	10	0	130	8
Ph-10-145-8	10	0	145	8
Ph-10-189-8	10	0	189	8
Ph-8-130-8	10	0	130	8
Ph-12-130-8	12	0	130	8
Ph-8-130-8	8	0	130	8
m-10-180 <sup>b</sup>	10	3	180	8
m-12-180	12	3	180	8
m-12-145	12	3	145	8
m-10-145	10	3	145	8
m-10-100	12	3	100	8
m-14-100	14	3	100	8
m-14-100	14	2	100	8

<sup>a</sup>Phenol formaldehyde, <sup>b</sup> melamine formaldehyde.

Different resin and hardener amount were used with different pressing temperature in order to find the best and cheapest way to increase the water resistance of the particleboard. During particleboard's production with phenol formaldehyde, wood particles stick together that made matt forming very hard. On the contrary, of melamine formaldehyde was very easy.

## RESULTS AND DISCUSSION

According to test results, Phenolformaldehyde resin is not suitable for production of water resistance wood particleboard since all board were over cooked and fall apart while boiling after only 15 min, while standard requires 2 hours of boiling, than put in cold water after that make the internal bond test, which has to be equal or more than 0.25 Mpa. In other hand the density of the board was good. Even with the change of resin amount and pressing temperature no good results was achieved See Table 2.

*Table 2: Density, boiling test and formaldehyde emission test results.*

Board ID	Density (g/cm <sup>3</sup> )	Boiling test	Formaldehyde emission
Ph-10-130-8 <sup>a</sup>	0.685	Over cooked	Higher than standard
Ph-10-145-8	0.625	Over cooked	Higher than standard
Ph-10-189-8	0.652	Over cooked	Higher than standard
Ph-8-130-8	0.676	Over cooked	Higher than standard
Ph-12-130-8	0.620	Over cooked	Higher than standard
Ph-8-130-8	0.672	Over cooked	Higher than standard
m-10-180 <sup>b</sup>	0.689	0.08	Higher than standard
m-12-180	0.700	0.10	Higher than standard
m-12-145	0.709	Over cooked	Higher than standard
m-10-145	0.693	Over cooked	Higher than standard
m-12-100	0.611	Over cooked	Higher than standard
m-14-100	0.655	0.26	Full-fill the standard
m-14-100	0.790	0.25	Full-fill the standard

<sup>a</sup>Phenol formaldehyde, <sup>b</sup> melamine formaldehyde.

On the other hand, melamineformaldehyde resin found to be suitable for production of water resistance particleboard with the use of certain parameters. Particleboard with 10 % and 12 % of resin, 3 % of hardener and temperature of 145 °C were over cooked. However with increase of pressing temperature to 180 °C specimens passed the bioling test but the internal bond was lower than the requirement with 0.08 Mpa and 0.10 Mpa. By using 14 % of melamine formeldehyde resin, 2 % and 3 % of hardener and pressing temperature of 100 °C, particle board fullfill the requirement with 0.25 Mpa and 0.26 Mpa of internal bond and low formaldehyde emission. For density for all board density was good however for board m-14-100 density was little higher than the standard with density of 0.790 g/cm<sup>3</sup>.

## CONCLUSIONS

Even with using different amount of adhesive the phenol formaldehyde resin particleboards could not pass the boiling test most of boards disintegrated after boiling in hot water. Since high amount of adhesive will increase the formaldehyde emission and low amount of adhesive could be not enough for the mechanical properties, 10 % of adhesive was used with pressing time 8 min. However, different pressing temperature were used (130, 145, 180 and 189 °C). As result, all produced board could not pass the boiling test most of boards disintegrated after only 25 min of boiling. However, the density was good for all boards.

Melamine formaldehyde proved to be suitable resin for production of water resistance particleboard with the use of exact parameters like using 14 % of resin, 3 % of hardener and 100 °C of pressing temperature. Not only achieve good internal bond after boiling in hot water but low formaldehyde emission. Which made it eco-friendly product.

## ACKNOWLEDGEMENT

This work was produced within the framework of “EFOP-3.6.1-16-2016-00018 projects.

## REFERENCES

Kim, M.H., Song, H.B., 2014. Analysis of the global warming potential for wood waste recycling systems. *J. Clean. Prod.* 69, 199–207. <https://doi.org/10.1016/j.jclepro.2014.01.039>

EN 1087-1:1996 - Particleboards - Determination of moisture resistance - Part 1: Boil test.

Dziurka, D., & Mirski, R. (2010). UF-pMDI hybrid resin for waterproof particleboards manufactured at a shortened pressing time. *Drvna industrija*, 61(4), 245-249.

Sugita, T., Ishiwata, H., & Yoshihira, K. (1990). *Release of formaldehyde and melamine from tableware made of melamine — formaldehyde resin. Food Additives and Contaminants*, 7(1), 21–27. doi:10.1080/02652039009373815

Devallencourt, C., Saiter, J. M., Fafet, A., & Ubrich, E. (1995). Thermogravimetry/Fourier transform infrared coupling investigations to study the thermal stability of melamine formaldehyde resin. *Thermochimica acta*, 259(1), 143-151.